

# PATENT ASSIGNMENT

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
<b>CONVEYING PARTY DATA</b>															
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Ching-Chun Lin</td> <td>03/15/2010</td> </tr> <tr> <td>Wing-Kai Tang</td> <td>03/16/2010</td> </tr> <tr> <td>Ching-Ho Hung</td> <td>03/15/2010</td> </tr> <tr> <td>Tsen-Wei Chang</td> <td>03/15/2010</td> </tr> <tr> <td>Yi-Liang Lin</td> <td>03/15/2010</td> </tr> <tr> <td>Jiun-Jie Tsai</td> <td>03/15/2010</td> </tr> </tbody> </table>		Name	Execution Date	Ching-Chun Lin	03/15/2010	Wing-Kai Tang	03/16/2010	Ching-Ho Hung	03/15/2010	Tsen-Wei Chang	03/15/2010	Yi-Liang Lin	03/15/2010	Jiun-Jie Tsai	03/15/2010
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Novatek Microelectronics Corp</td> </tr> <tr> <td>Street Address:</td> <td>2F, No. 13, Innovation Road I, Science-Based Industrial Park</td> </tr> <tr> <td>City:</td> <td>Hsinchu</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> </table>		Name:	Novatek Microelectronics Corp	Street Address:	2F, No. 13, Innovation Road I, Science-Based Industrial Park	City:	Hsinchu	State/Country:	TAIWAN						
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<b>PROPERTY NUMBERS Total: 1</b>															
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<b>CORRESPONDENCE DATA</b>															
<p>Fax Number: (949)660-0809</p> <p><i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Email: usa@jcgipgroup.com.tw</p> <p>Correspondent Name: JIANQ CHYUN INTELLECTUAL PROPERTY</p> <p>Address Line 1: 7F.-1, NO.100, ROOSEVELT RD., SEC. 2,</p> <p>Address Line 4: TAIPEI, TAIWAN 100</p>															
ATTORNEY DOCKET NUMBER:	33007-US-PA														
NAME OF SUBMITTER:	Belinda Lee														
<p>Total Attachments: 2</p> <p>source=33007US_ASSGN#page1.tif</p>															

CH \$40.00 13037364

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**PATENT**  
**REEL: 025899 FRAME: 0570**



NVT-2009-111  
33007-US-PA

## ASSIGNMENT

WHEREAS,

- |                    |                    |
|--------------------|--------------------|
| 1. Lin, Ching-Chun | 2. Tang, Wing-Kai  |
| 3. Hung, Ching-Ho  | 4. Chang, Tsen-Wei |
| 5. Lin, Yi-Liang   | 6. Tsai, Jiun-Jie  |

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful Improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **SENSING AND DRIVING APPARATUS, TOUCH SENSING SYSTEM, AND SENSING AND DRIVING METHOD**

[ ] Filed: Serial No.

[x] Executed concurrently with the execution of this instrument

WHEREAS, Novatek Microelectronics Corp.

of 2F, No. 13, Innovation Road I, Science-Based Industrial Park, Hsinchu, Taiwan,  
R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

NVT-2009-111  
33007-US-PA

## ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Lin, Ching-Chun  
Sole or First Joint Inventor: Lin, Ching-Chun

Date: 2010. 3. 15.

Signature: Tang, Wing-Kai  
Second Joint Inventor (if any): Tang, Wing-Kai

Date: 2010, 3. 16

Signature: Hung, Ching-Ho  
Third Joint Inventor (if any): Hung, Ching-Ho

Date: Mar, 15, 2010

Signature: Chang, Tsen-Wei  
Fourth Joint Inventor (if any): Chang, Tsen-Wei

Date: 2010. 03. 15

Signature: Lin Yi-Liang  
Fifth Joint Inventor (if any): Lin, Yi-Liang

Date: 2010. 03. 15

Signature: Tsai, Jiun-Jie  
Sixth Joint Inventor (if any): Tsai, Jiun-Jie

Date: 2010. 03. 15